

TIP115/116/117

Monolithic Construction With Built In Base-Emitter Shunt Resistors

- High DC Current Gain : h_{FE} =1000 @ V_{CE} = -4V, I_{C} = -1A (Min.)
- Low Collector-Emitter Saturation Voltage
- Industrial Use
- Complementary to TIP110/111/112

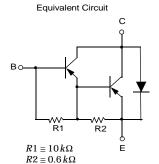


1.Base 2.Collector 3.Emitter

PNP Epitaxial Silicon Darlington Transistor

Absolute Maximum Ratings T_C=25°C unless otherwise noted

Symbol	Parameter	Value	Units
V _{CBO}	Collector-Base Voltage : TIP115	- 60	V
	: TIP116	- 80	V
	: TIP117	- 100	V
	Collector-Emitter Voltage: TIP115	- 60	V
V_{CEO}	: TIP116	- 80	V
	: TIP117	- 100	V
V _{EBO}	Emitter-Base Voltage	- 5	V
I _C	Collector Current (DC)	- 2	Α
I _{CP}	Collector Current (Pulse)	-4	Α
I _B	Base Current (DC)	- 50	mA
P _C	Collector Dissipation (T _a =25°C)	2	W
	Collector Dissipation (T _C =25°C)	50	W
T _J	Junction Temperature	150	°C
T _{STG}	Storage Temperature	- 65 ~ 150	°C



Electrical Characteristics ${\rm T_{C}\text{=}25^{\circ}C}$ unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Max.	Units
V _{CEO} (sus)	Collector-Emitter Sustaining Voltage				
	: TIP115	$I_C = -30 \text{mA}, I_B = 0$	-60		V
	: TIP116		-80		V
	: TIP117		-100		V
I _{CEO}	Collector Cut-off Current				
	: TIP115	$V_{CE} = -30V, I_{B} = 0$		-2	mA
	: TIP116	$V_{CE} = -40V, I_{B} = 0$		-2	mA
	: TIP117	$V_{CE} = -50V, I_{B} = 0$		-2	mA
I _{CBO}	Collector Cut-off Current				
	: TIP115	$V_{CB} = -60V, I_{E} = 0$		-1	mA
	: TIP116	$V_{CB} = -80V, I_{E} = 0$		-1	mA
	: TIP117	$V_{CB} = -100V, I_{E} = 0$		-1	mA
I _{EBO}	Emitter Cut-off Current	$V_{BE} = -5V, I_{C} = 0$		-2	mA
h _{FE}	DC Current Gain	$V_{CE} = -4V, I_{C} = -1A$	1000		
		$V_{CE} = -4V, I_{C} = -2A$	500		
V _{CE} (sat)	Collector-Emitter Saturation Voltage	$I_C = -2A, I_B = -8mA$		-2.5	V
V _{BE} (on)	Base-Emitter ON Voltage	$V_{CE} = -4V, I_{C} = -2A$		-2.8	V
C _{ob}	Output Capacitance	$V_{CB} = -10V, I_E = 0, f = 0.1MHz$		200	pF

Typical Characteristics

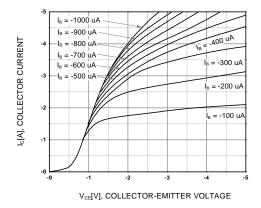


Figure 1. Static Characteristic

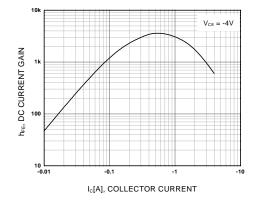


Figure 2. DC current Gain

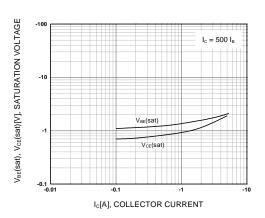


Figure 3. Collector-Emitter Saturation Voltage Base-Emitter Saturation Voltage

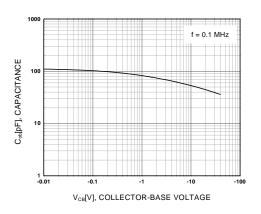


Figure 4. Collector Output Capacitance

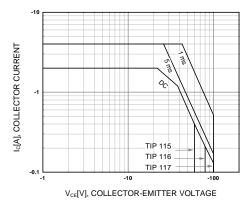


Figure 5. Safe Operating Area

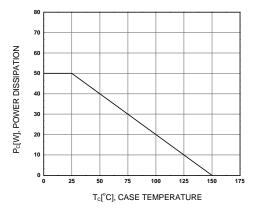
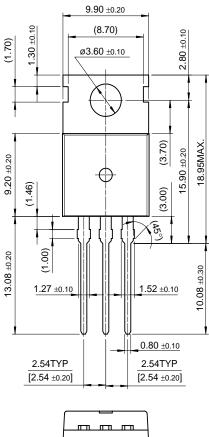


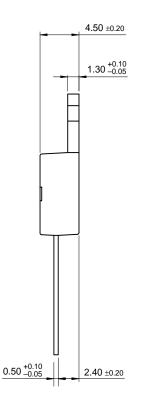
Figure 6. Power Derating

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Package Demensions

TO-220





10.00 ±0.20

Dimensions in Millimeters

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